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FDD6780A / FDU6780A_F071 N-Channel PowerTrench[®] MOSFET

25 V, 8.6 m Ω

Features

- Max $r_{DS(on)}$ = 8.6 m Ω at V_{GS} = 10 V, I_D = 16.4 A
- Max $r_{DS(on)}$ = 19.0 m Ω at V_{GS} = 4.5 V, I_D = 12.2 A
- 100% UIL test
- RoHS Compliant

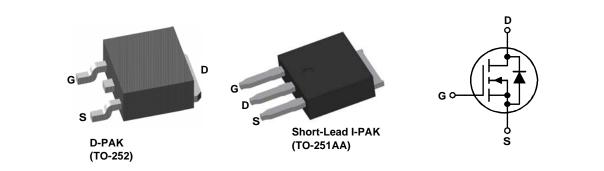


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$ and fast switching speed.

Applications

- Vcore DC-DC for Desktop Computers and Servers
- VRM for Intermediate Bus Architecture



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		30		
	-Continuous (Silicon limited) $T_{C} = 25 \text{ °C}$			48	٨	
	-Continuous	T _A = 25 °C	(Note 1a)	16.4	A	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	24	mJ	
P _D	Power Dissipation $T_{C} = 25 \text{ °C}$			32.6	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.7	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case TO-252, TO-251	4.6	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient TO-252 (Note	la) 40	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6780A	FDD6780A	D-PAK (TO-252)	13 "	16 mm	2500 units
FDU6780A	FDU6780A_F071	TO-251AA	N/A(Tube)	N/A	75 units

March 2015

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V 25				V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		14		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V			1	μΑ	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA	
On Chara	acteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA 1.0		1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-5		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 16.4 A		6.8	8.6	_	
		V _{GS} = 10 V, I _D = 16.4 A Short-Lead I-PAK version		7.0	8.8		
		V_{GS} = 4.5 V, I_{D} = 12.2 A		14.1 19.0 r			
		V _{GS} = 4.5 V, I _D = 12.2 A Short-Lead I-PAK version		14.3	19.2	_	
		V_{GS} = 10 V, I _D = 16.4 A, T _J = 150 °C		10.3	13.0		
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 16.4 A		70		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			927	1235	pF	
C _{oss}	Output Capacitance	−V _{DS} = 13 V, V _{GS} = 0 V, −f = 1MHz		197	265	pF	
C _{rss}	Reverse Transfer Capacitance			181	275	pF	
R _g	Gate Resistance	f = 1MHz		1.2		Ω	
Switchin	g Characteristics						
t _{d(on)}	Turn-On Delay Time			7	14	ns	
t _r	Rise Time	V _{DD} = 13 V, I _D = 16.4 A,		3	10	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		16	29	ns	
t _f	Fall Time			3	10	ns	
Qg	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		17	24	nC	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 13 V,$		9.2	13	nC	
Q _{gs}	Gate to Source Charge	I _D = 16.4 A		2.8		nC	
Q _{gd}	Gate to Drain "Miller" Charge			4.0		nC	
Drain-So	ource Diode Characteristics						
M	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 3.1 A$ (Note 2)		0.8	1.2	V	
V _{SD}		$V_{GS} = 0 V, I_S = 16.4 A$ (Note 2)		0.9	1.3	V	
4				45	07		

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t_{rr}

Q_{rr}

Reverse Recovery Time

Reverse Recovery Charge

ns

nC

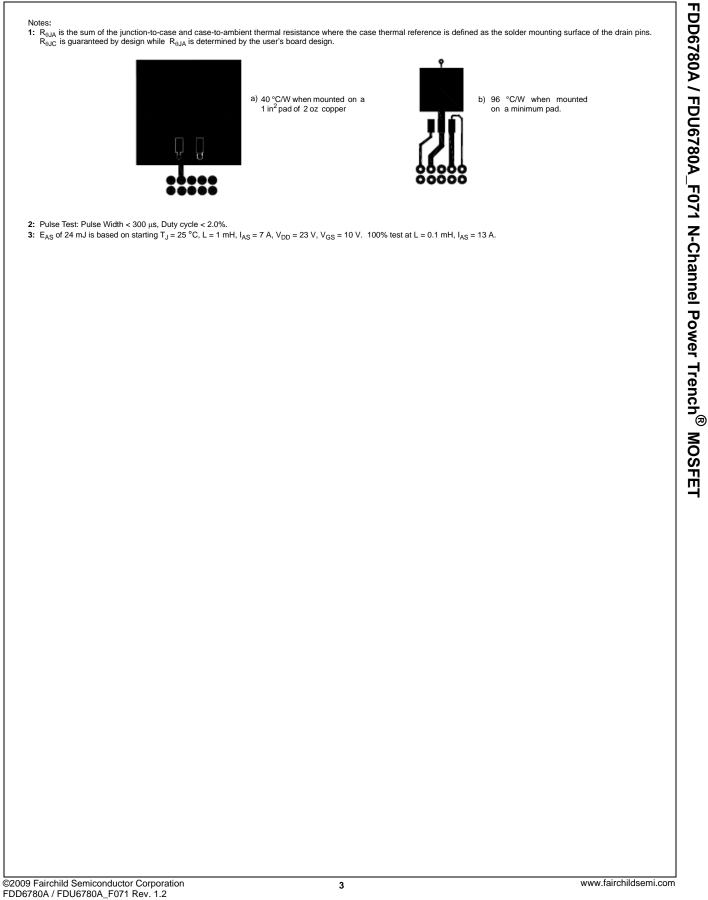
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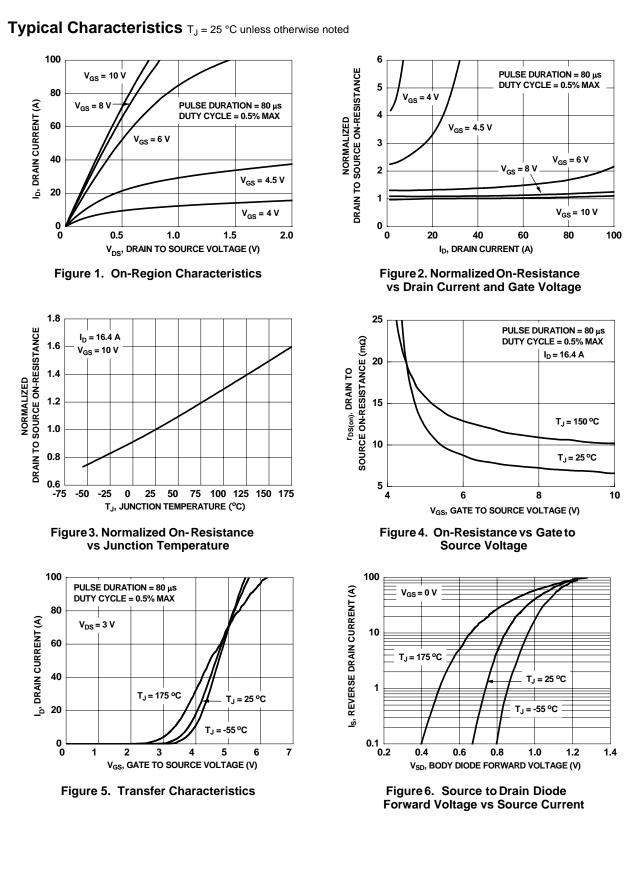
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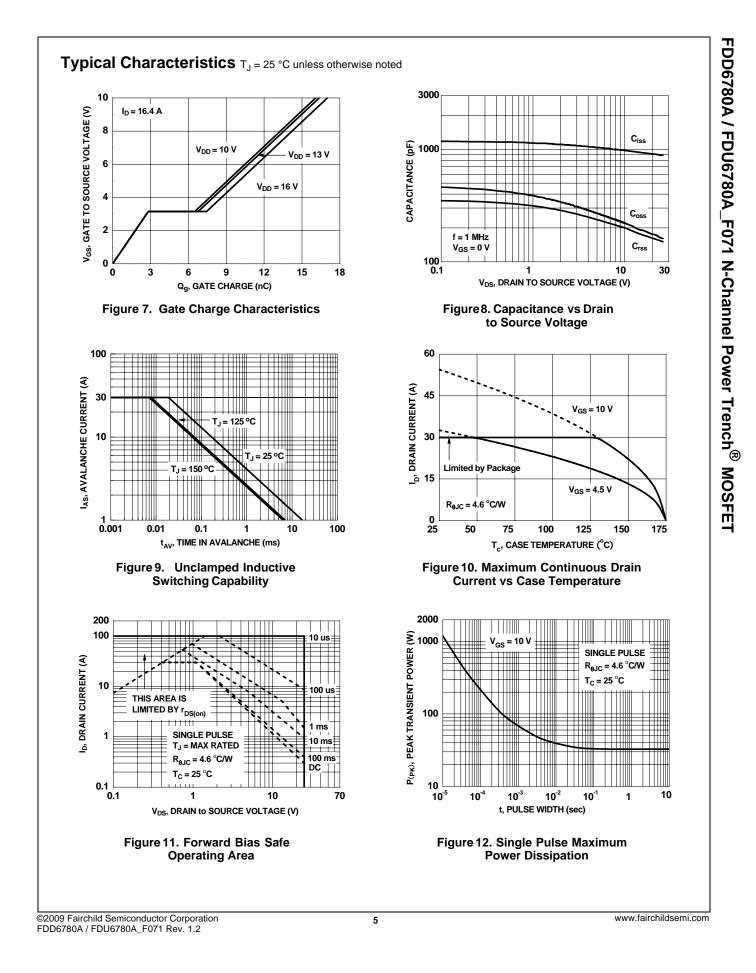
 $I_F = 16.4 \text{ A}, \, di/dt = 100 \text{ A}/\mu \text{s}$

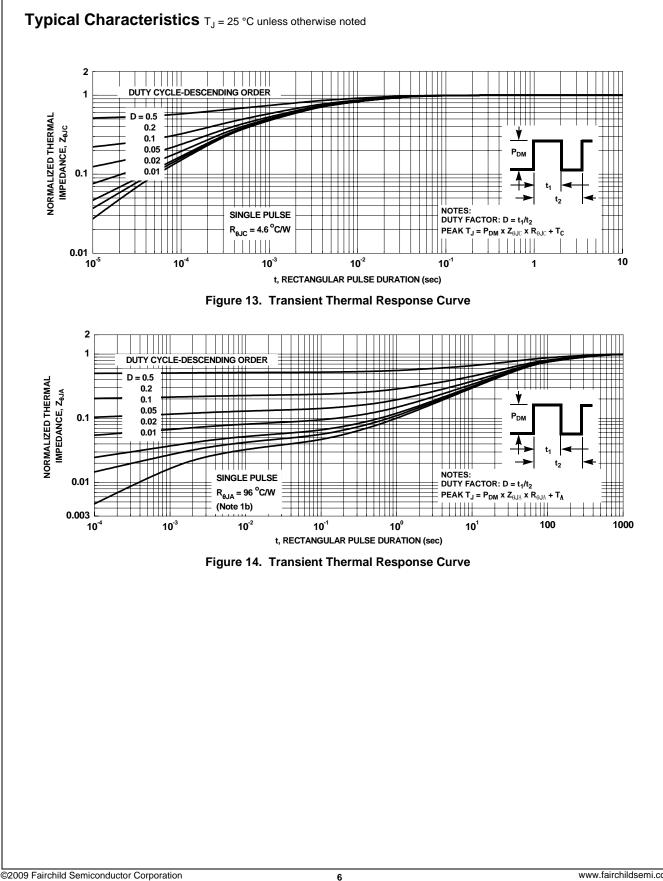




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